

PRELIMINARY DATASHEETS

Parallel 1200 2X30A Fast Recovery Epitaxial Diode in Isolated SOT227 package

APPLICATIONS

- Switch mode power supplies (SMPS) rectifiers
- Uninterruptible power supplies (UPS)
- Ultrasonic cleaners and welders
- Inductive heating and melting
- > Ultrasonic cleaners and welders
- Power factor correction (PFC) circuits
- Inversion welder
- Converter and chopper

FEATURES

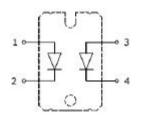
- Ultrafast recovery time
- Soft recovery characteristics
- Low recovery loss
- Low forward voltage
- High surge current capability
- Low leakage current
- Pb free finished; RoHS compliant



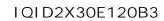
| Parameter | Symbol | Value | Units |
|--|------------------|----------|-------|
| Repetitive peak reverse voltage | V _{RRM} | 1200 | V |
| Continuous forward current T _C = 85°C | IF | 30 | |
| Surge non-repetitive forward current I_J = 45°C, t_p = 10 ms, 50Hz, Sine | IFSM | 300 | A |
| Operating junction and storage temperature | Tj, Tstg | -40 +150 | °C |

Thermal and Isolation Characteristics

| Parameter | Symbol | Max. Value | Units |
|--|------------------|------------|-------|
| Characteristics | | | |
| Thermal resistance, junction to case, per Diode | RthJC | 1.43 | ∘C/W |
| Isolation voltage, RMS (measured between terminals and mounting base, 50-60 Hz, for 1-3 seconds) | V _{iso} | 3000 | V |











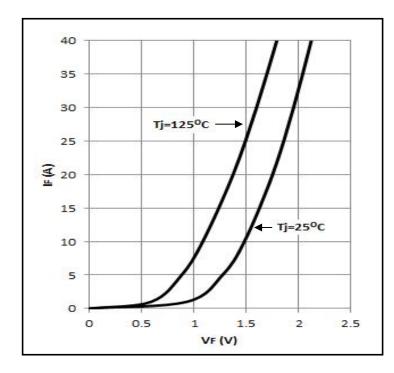
| Parameter | Symbol | Value | | | 11 |
|---|--------|-------|------------|------|------|
| | | Min. | Тур. | Max. | Unit |
| Static Characteristics | | | | | |
| Reverse leakage current V _R = 1200 V, Tj = 25 °C | IR | - | - | 100 | μA |
| Forward voltage drop $I_F = 30A, T_J = 25 \circ C$ $I_F = 30A, T_J = 125 \circ C$ | VF | - | 2.0 1.6 | 2.5 | V |

Electrical Characteristics (per Diode), at T_j = 25°C, unless otherwise specified

Electrical Characteristics (per Diode), at $T_j = 25^{\circ}C$, unless otherwise specified

| Parameter | Sumah al | Value | | | 11 |
|--|-----------------|-------------|------------------|--------|------|
| | Symbol | Min. | Тур. | Max. | Unit |
| Dynamic Characteristics | | | | | |
| Reverse recovery time $V_R = 30V$, $I_F = 1A$, $di_F/dt = -200A/\mu s$ $V_R = 600V$, $I_F = 30A$, $di_F/dt = -200A/\mu s$, $T_j = 25 \circ C$ $V_R = 600V$, $I_F = 30A$, $di_F/dt = -200A/\mu s$, $T_j = 125 \circ C$ | t _{rr} | - - - | 33 244 444 | - - | ns |
| Maximum reverse recovery current $V_R = 600V$, $I_F = 30A$, $di_F/dt = -200A/\mu_S$, $T_j = 25 \circ C$ $V_R = 600V$, $I_F = 30A$, $di_F/dt = -200A/\mu_S$, $T_j = 125 \circ C$ | Irrm | - | 9.1 16.6 | - | A |
| Reverse recovery charge V _R = 600V, I _F = 30A, di _F /dt = -200A/µs, T _j = 25 °C V _R = 600V, I _F = 30A, di _F /dt = -200A/µs, T _j = 125°C | Q _{rr} | - | 758 4065 | - | nC |

Figure 1 – Forward voltage drop vs forward current



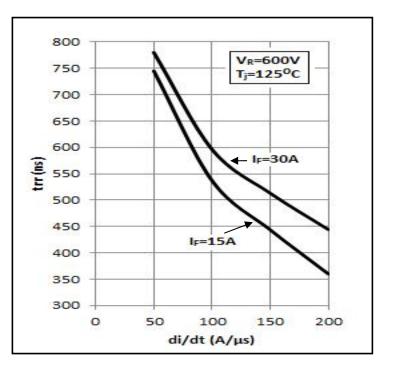


Figure 2 – Reverse recovery time vs di_F/dt

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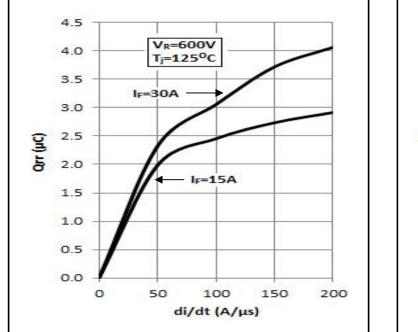


Figure 3 – Reverse recovery charge vs di_F/dt

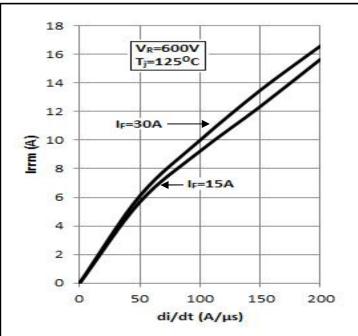
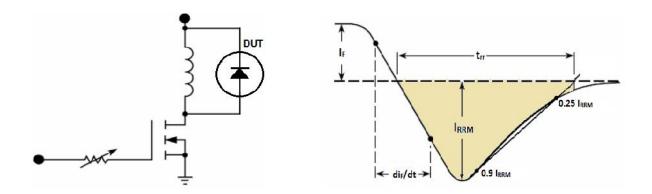




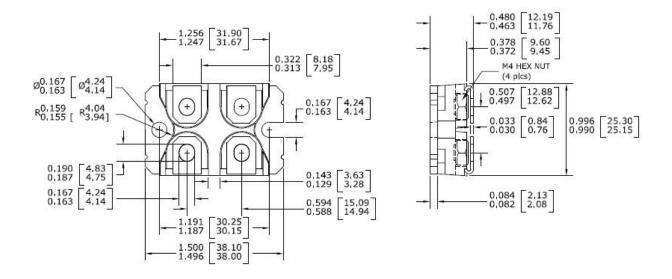
Figure 5 – Diode Reverse Recovery Test Circuit and Waveform







Package Outline Drawing



Disclaimer

These specifications may not be considered as a guarantee of components characteristics. Components have to be tested depending on intended application as adjustments may be necessary. The use of **iQXPRZ Power Inc.** components in life support appliances and systems are subject to written approval of **iQXPRZ Power Inc.**

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